



DMT35M4LFDF

### Product Summary

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
30V	6mΩ @ V <sub>GS</sub> = 10V	13A
307	10.5mΩ @ V <sub>GS</sub> = 4.5V	10A

# Description

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

# Applications

- General Purpose Interfacing Switch
- Power Management Functions

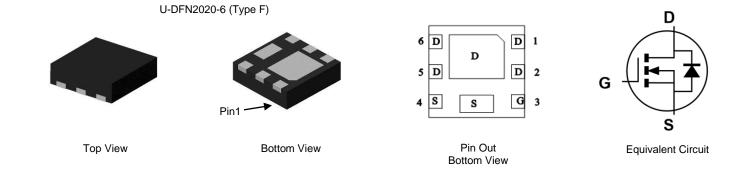
#### **30V N-CHANNEL ENHANCEMENT MODE MOSFET**

#### Features

- 0.6mm Profile Ideal for Low-Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low Gate Threshold Voltage
- Low On-Resistance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

### **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.007 grams (Approximate)



# Ordering Information (Note 4)

Part Number	Case	Packaging
DMT35M4LFDF-7	U-DFN2020-6 (Type F)	3,000/Tape & Reel
DMT35M4LFDF-13	U-DFN2020-6 (Type F)	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

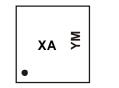
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

Site 1



XA = Product Type Marking Code YM = Date Code MarkingY = Year (ex: H = 2020)M = Month (ex: 9 = September)

Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н	_	J	K	L	М	Ν	0	Р	R	S
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



XA = Product Type Marking Code

YWX = Date Code Marking

Y = Year (ex: 0 = 2020)

W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key												
Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	9	0	1	2	3	4	5	6	7	8	9	0
	-											
Week	1-26			27-52				53				
Code		A-Z			a-z			Z				
			r					1				
Internal Code	Sı	ın	Mor	า	Tue	1	Wed	Thu	I	Fri		Sat
Code	7		U		V		W	Х		Y		Z



#### **Maximum Ratings** (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	30	V		
Gate-Source Voltage	Vgss	±20	V		
	Steady	Tc = +25°C		13	٨
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6)	State	Tc = +70°C	ID	11	A
Maximum Body Diode Forward Current		Is	2.4	А	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 19	%)		Ідм	90	А
Pulsed Drain Body Diode Forward Current (380µs F	ulse, Duty Cycle	e = 1%)	lsм	90	A
Avalanche Current (L = 0.1mH) (Note 8)		I <sub>AS</sub>	22	А	
Avalanche Energy (L = 0.1mH) (Note 8)			Eas	25	mJ

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		Po	0.86	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	147	°C/W
Total Power Dissipation (Note 6)		Po	1.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	73	°C/W
Thermal Resistance, Junction to Case (Note 7)		Rejc	6.7	C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)		-				-	
Drain-Source Breakdown Voltage	BVDSS	30	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	IDSS	_	_	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.15	—	2.5	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Preven		4.9	6	mΩ	VGS = 10V, ID = 20A	
Static Dialit-Source Of-Resistance	R <sub>DS(ON)</sub>		7.1	10.5	11122	$V_{GS} = 4.5V, I_D = 15A$	
Diode Forward Voltage	Vsd		0.7	1	V	$V_{GS} = 0V$ , $I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		1009	—		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	925	—	pF		
Reverse Transfer Capacitance	Crss	_	50	-		1 = 1.00012	
Gate Resistance	Rg		2	—	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	8.1	-			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	14.9	—	nC		
Gate-Source Charge	Qgs	—	2.3	—	nc	Vdd = 15V, Id = 9A	
Gate-Drain Charge	Q <sub>gd</sub>	_	3.4	—			
Turn-On Delay Time	td(on)	-	3.6	-			
Turn-On Rise Time	tR	_	4.4	—		V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	15	_	ns	$R_g = 3\Omega$ , $I_D = 9A$	
Turn-Off Fall Time	tF	_	6.9	—			
Reverse Recovery Time	trr	_	29.4	—	ns		
Reverse Recovery Charge	Qrr		19.2	_	nC	I <sub>F</sub> = 1.5A, di/dt = 100A/µs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

Bevice mounted on FR-4 bloadd, with minimum recommended pad layout, single steed.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).

8. I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

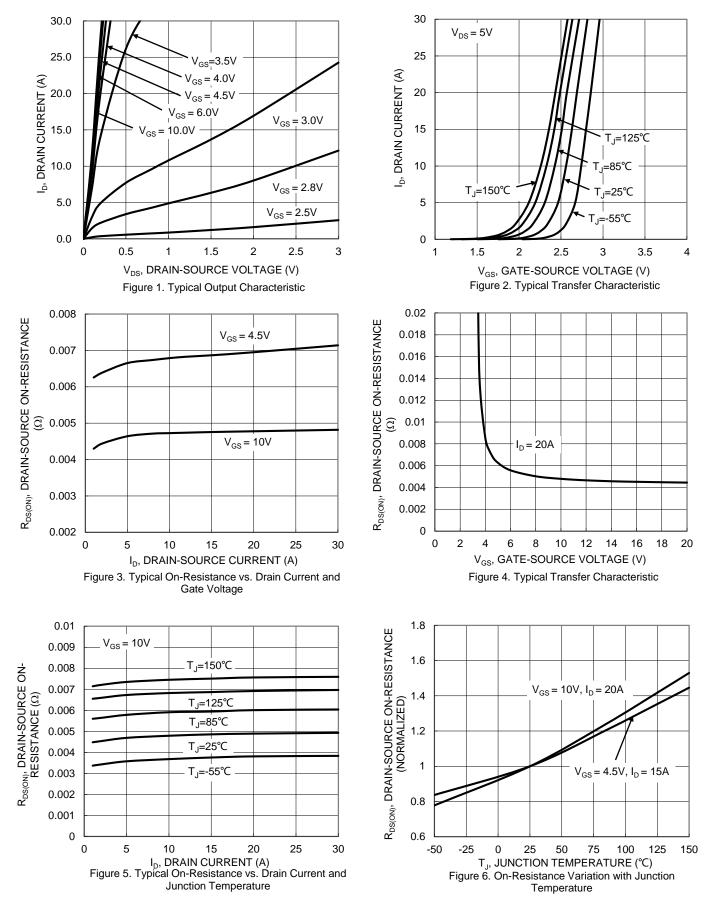
9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

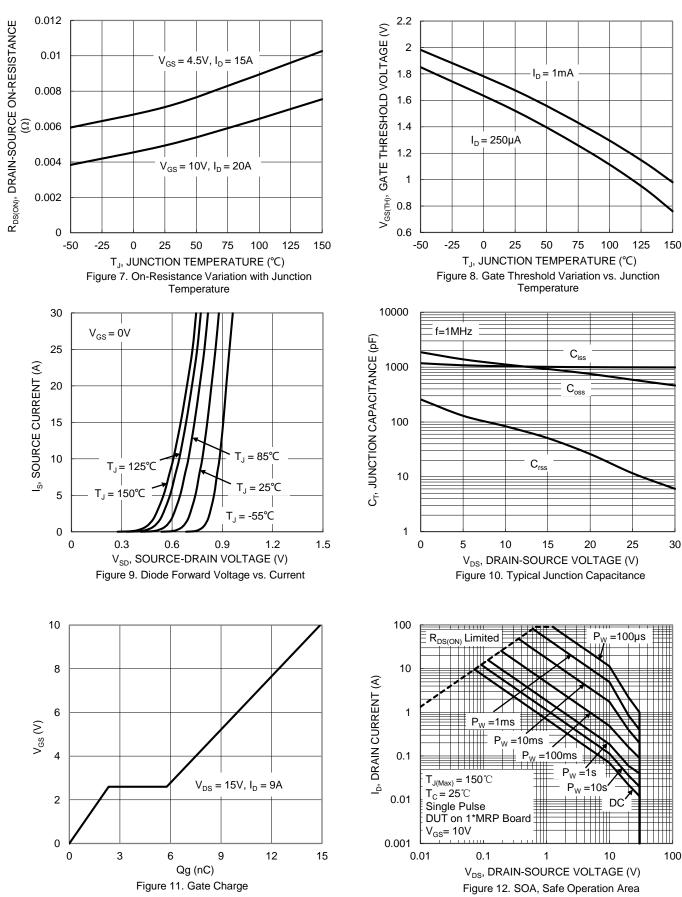
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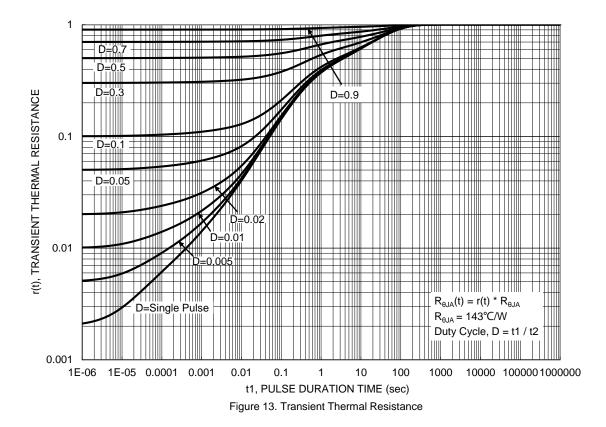








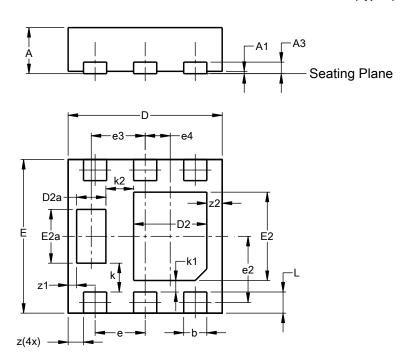






# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.



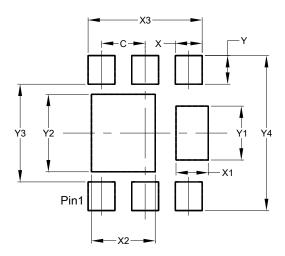
U-DFN2020-6 (Typ	be F)

U-DFN2020-6							
		be F)					
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0.00	0.05	0.03				
A3	_		0.15				
b	0.25	0.35	0.30				
D	1.95	2.05	2.00				
D2	0.85	1.05	0.95				
D2a	0.33	0.43	0.38				
Е	1.95	2.05	2.00				
E2	1.05	1.25	1.15				
E2a	0.65	0.75	0.70				
е	0.65 BSC						
e2	0.863 BSC						
e3		0.70 BS					
e4	C	).325 BS	SC				
k		0.37 BS	С				
k1	0.15 BSC						
k2		0.36 BS	С				
L	0.225	0.325	0.275				
z		0.20 BS	С				
z1	C	).110 BS	SC				
z2		0.20 BS	С				
All D	imens	ions in	mm				

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### U-DFN2020-6 (Type F)



Dimensions	Value (in mm)
С	0.650
Х	0.400
X1	0.480
X2	0.950
X3	1.700
Y	0.425
Y1	0.800
Y2	1.150
Y3	1.450
Y4	2.300



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